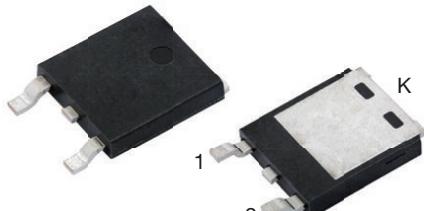


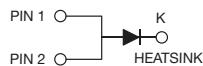
High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low V_F = 0.50 V at I_F = 5 A

eSMP® Series



SlimDPAK (TO-252AE)



LINKS TO ADDITIONAL RESOURCES



AUTOMOTIVE GRADE
Available



RoHS
COMPLIANT
HALOGEN
FREE

FEATURES

- Very low profile - typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meets JESD 201 class 2 whisker test

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	35 A
V_{RRM}	150 V
I_{FSM}	260 A
V_F at I_F = 35 A (T_A = 125 °C)	0.71 V
T_J max.	150 °C
Package	SlimDPAK (TO-252AE)
Circuit configuration	Single

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)

PARAMETER	SYMBOL	V35PW15	UNIT
Device marking code		V35PW15	
Maximum repetitive peak reverse voltage	V_{RRM}	150	V
Maximum average forward rectified current (Fig. 1)	$I_{F(AV)}$ ⁽¹⁾	35	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	260	A
Operating junction temperature range	T_J ⁽²⁾	-40 to +150	°C
Storage temperature range	T_{STG}	-55 to +150	°C

Notes

(1) With infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Maximum Instantaneous forward voltage	$I_F = 5.0 \text{ A}$	$T_A = 25^\circ\text{C}$	V_F ⁽¹⁾	0.61	-	V	
	$I_F = 17.5 \text{ A}$			0.90	-		
	$I_F = 35 \text{ A}$			1.32	1.40		
	$I_F = 5.0 \text{ A}$	$T_A = 125^\circ\text{C}$		0.50	-		
	$I_F = 17.5 \text{ A}$			0.65	-		
	$I_F = 35 \text{ A}$			0.71	0.79		
Reverse current	$V_R = 100 \text{ V}$	$T_A = 25^\circ\text{C}$	I_R ⁽²⁾	0.01	-	mA	
		$T_A = 125^\circ\text{C}$		4	-		
	$V_R = 150 \text{ V}$	$T_A = 25^\circ\text{C}$		-	0.25		
		$T_A = 125^\circ\text{C}$		9	25		
Typical junction capacitance	4.0 V, 1 MHz		C_J	1620	-	pF	

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width $\leq 5 \text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V35PW15		UNIT
Typical thermal resistance	$R_{\theta JA}$ ⁽¹⁾⁽²⁾	55		°C/W
	$R_{\theta JM}$ ⁽³⁾	1.5		

Notes

(1) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

(3) Mounted on infinite heatsink; thermal resistance $R_{\theta JM}$ - junction-to-mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V35PW15-M3/I	0.20	I	4500	13" diameter plastic tape and reel
V35PW15HM3/I ⁽¹⁾	0.20	I	4500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

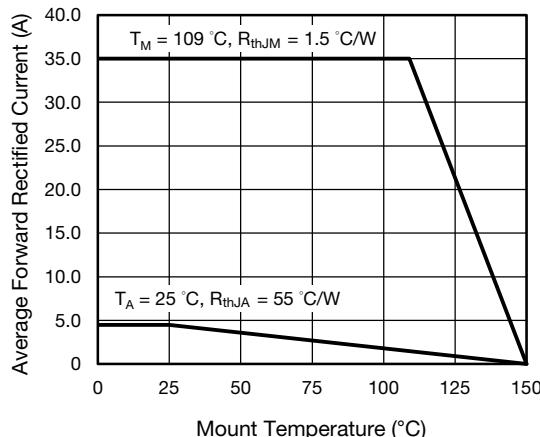
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

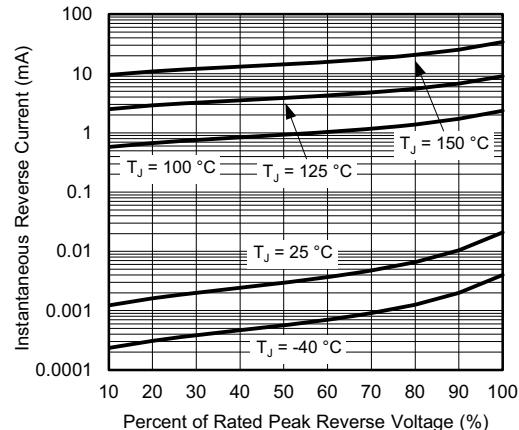


Fig. 4 - Typical Reverse Leakage Characteristics

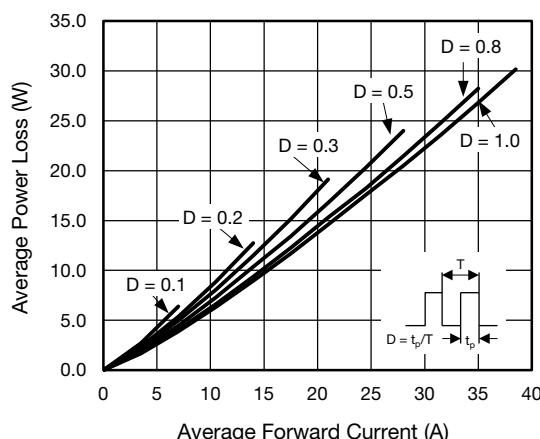


Fig. 2 - Forward Power Loss Characteristics

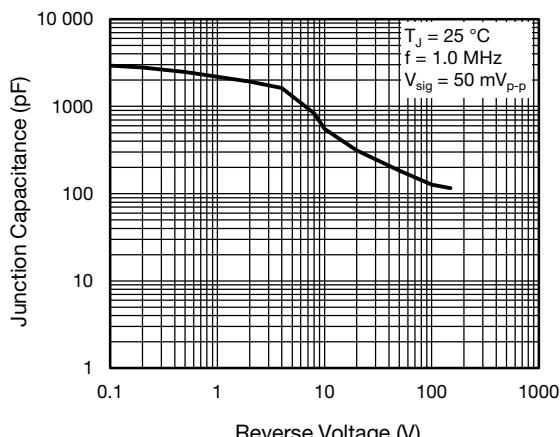


Fig. 5 - Typical Junction Capacitance

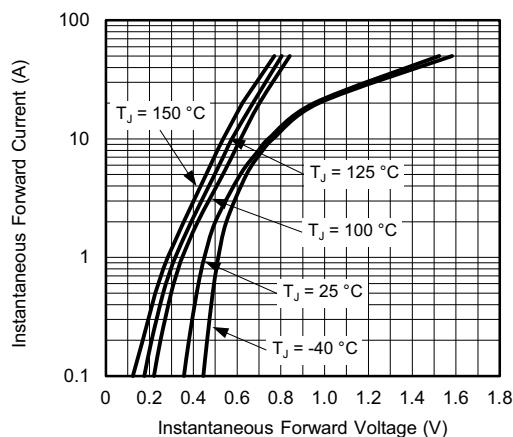


Fig. 3 - Typical Instantaneous Forward Characteristics

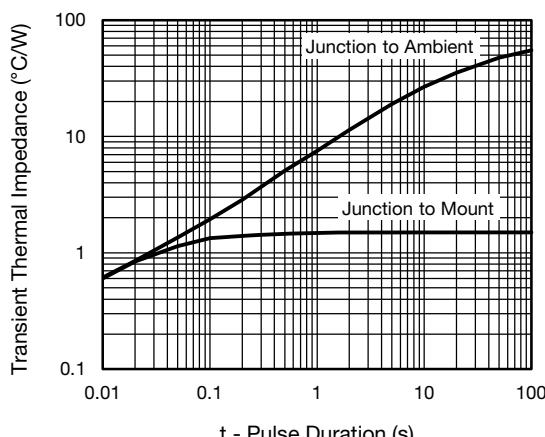


Fig. 6 - Typical Transient Thermal Impedance

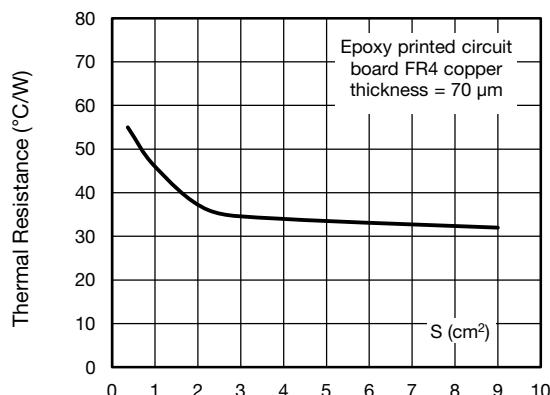
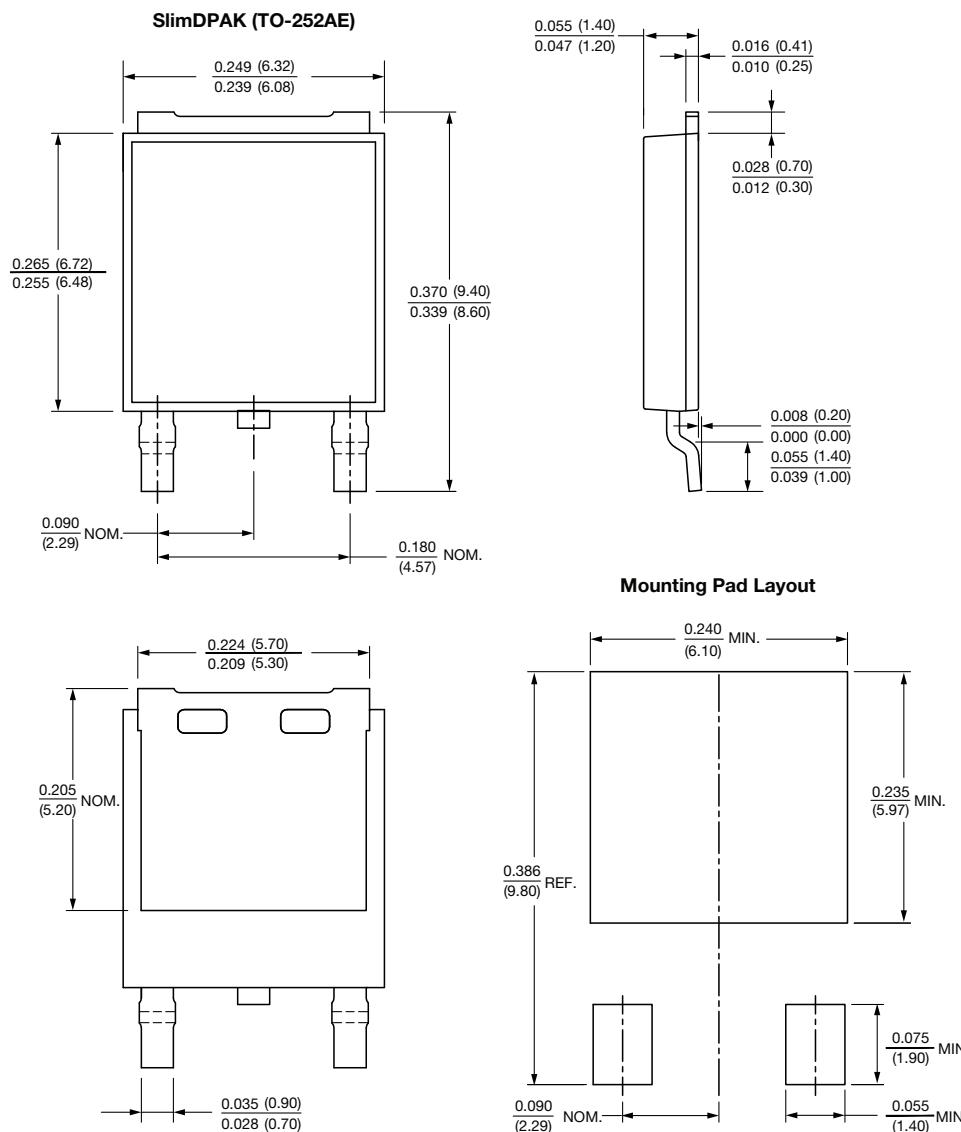


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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